

BCX19

NPN Medium Power Transistor

- This device is designed for general purpose amplifiers.
- Sourced from process 38.



1. Base 2. Emitter 3. Collector

Absolute Maximum Ratings $T_C=25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Value	Units
V_{CEO}	Collector-Emitter Voltage		45	V
V _{CBO}	Collector-Base Voltage		50	V
V _{EBO}	Emitter-Base Voltage		5.0	V
I _C	Collector current	- Continuous	500	mW
T _J , T _{stq}	Junction and Storage Temperature		-55 ~ +150	°C

Electrical Characteristics T_{C} =25°C unless otherwise noted

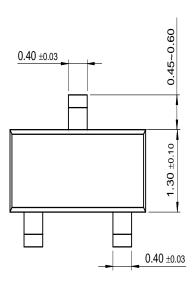
Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charact	Off Characteristics					
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage	$I_C = 10 \text{mA}, I_B = 0$	45			V
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	$I_{C} = 10\mu A, I_{C} = 0$	50			V
I _{CBO}	Collector Cutoff Current	V _{CB} = 20V, I _E = 0 V _{CB} = 20V, I _E = 0, T _A = 150°C			100 5.0	nA μA
I _{EBO}	Emitter Cutoff Current	V _{EB} = 5.0V, I _C = 0			10	μΑ
On Characteristics						
h _{FE}	DC Current Gain	I _C = 100mA, V _{CE} = 1.0V I _C = 300mA, V _{CE} = 1.0V I _C = 500mA, V _{CE} = 1.0V	100 70 40		600	
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C = 500mA, I _B = 50mA			0.62	V
V _{BE(on)}	Base-Emitter On Voltage	I _C = 500mA, V _{CE} = 1.0V			1.2	V

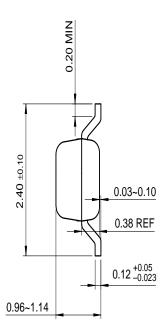
Thermal Characteristics $T_A=25$ °C unless otherwise noted

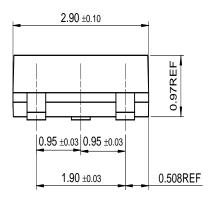
Symbol	Parameter	Max.	Units	
P_{D}	Total Device Dissipation Derate above 25°C	300 2.4	mW mW/°C	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	417	°C/W	

Package Dimensions

SOT-23







Dimensions in Millimeters

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